



**EXPEDITED PROCEDURE – EXAMINING GROUP 2835**

**09/897320**

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	George Hsieh	Examiner:	Gregory Thompson
Serial No.:	09/897320	Group Art Unit:	2835
Filed:	June 29, 2001	Docket No.:	884.462US1
Title:	ELECTRONIC ASSEMBLY WITH SOLDERABLE HEAT SINK AND METHODS OF MANUFACTURE		
Assignee:	Intel Corporation	Customer No.:	21186

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**AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116**

Mail Stop RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In response to the Final Office Action mailed January 20, 2004, please amend the application as set forth below.

This response is accompanied by a Request for Continuing Examination, as well as the appropriate fee, and a Petition, as well as the appropriate fee, to obtain a one month extension of the period for responding to the Office action, thereby moving the deadline for response from April 20, 2004 to May 20, 2004.